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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of

You-seop LEE, et al.

Art Unit: 2853

Serial No. 10/757,391

Examiner:

Filed: January 15, 2004

Confirmation No. 4946

For: INK EJECTING METHOD AND INK-JET  
PRINthead UTILIZING THE METHOD

**TRANSMITTAL OF SUPPLEMENTAL DECLARATION COPY  
and REQUEST FOR CORRECTED FILING RECEIPT**

Commissioner for Patents  
Alexandria, VA 22313-1450

Sir:

Kindly enter the enclosed supplemental Declaration copy into the record of the captioned application. This declaration copy clearly confirms the spelling of the name of the third inventor, Yong-soo OH, which appears incorrectly on the Official Filing Receipt.

Issuance of a Corrected Filing Receipt is solicited.

Respectfully submitted,

October 25, 2004  
Date

Eugene M. Lee, Registration No. 32,039

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**DEPOSIT ACCOUNT CHARGE AUTHORIZATION**

If fee payment is enclosed, this amount is believed to be correct. However, the Director is hereby authorized to charge any deficiency or credit any overpayment to Deposit Account No. 50-1645.

Any additional fee(s) necessary to effect the proper and timely filing of the above-paper may also be charged to Deposit Account No. 50-1645.



BEST AVAILABLE COPY

Doclet No. 249/436

## DECLARATION AND POWER OF ATTORNEY

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

**INK EJECTING METHOD AND INK-JET PRINthead UTILIZING THE METHOD**  
the specification of which is attached hereto unless the following box is checked:

was filed on \_\_\_\_\_ as United States Application Number or PCT International Application Number \_\_\_\_\_ and was amended on \_\_\_\_\_ (if applicable).

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is known by me to be material to patentability as defined in Title 37, Code of Federal Regulations 1.56.

I hereby claim foreign priority benefits under Title 35, United States Code, 119(a)-(d) or 365(h) of any foreign application(s) for patent or inventor's certificate, or 365(a) of any PCT International application which designated at least one country other than the United States, listed below and have also identified below any foreign application for patent or inventor's certificate, or PCT International application having a filing date before that of the application on which priority is claimed:

### PRIOR FOREIGN APPLICATION(S)

NUMBER	COUNTRY	DAY/MONTH/YEAR FILED	PRIORITY CLAIMED
2003-2729	Republic of Korea	15/January/2003	Yes

I hereby claim the benefit under Title 35, United States Code 119(c) of any United States provisional application(s) listed below.

APPLICATION NO.	FILING DATE

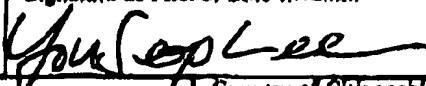
I hereby claim the benefit under Title 35, United States Code, 120 of any United States application(s), or 365(c) of any PCT International application designating the United States, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT International application in the manner provided by the first paragraph of Title 35, United States Code, 112, I acknowledge the duty to disclose information which is known by me to be material to patentability as defined in Title 37, Code of Federal Regulations 1.56 which became available between the filing date of the prior application and the national or PCT International filing date of this application:

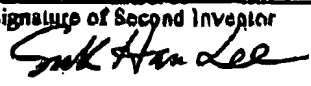
APPLICATION SERIAL NO.	FILING DATE	STATUS: PATENTED, PENDING, ABANDONED


I hereby appoint as my attorneys, with full powers of substitution and revocation, to prosecute this application and transact all business in the Patent and Trademark Office connected therewith: Eugene M. Lee, Reg. No. 32,039; Richard A. Sieha, Reg. No. 43,162.

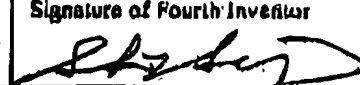
Address all correspondence to Eugene M. Lee, LEE & STERBA, P.C., 1101 Wilson Boulevard, Suite 2000, Arlington, Virginia 22209. Address all telephone communications to Eugene M. Lee at (703) 525-0978.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like are made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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